Small Signal MOSFET

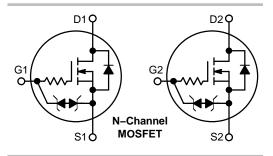
23 V, 200 mA, Dual N-Channel, 0.65 mm x 0.90 mm x 0.4 mm XLLGA-6 Package



ON Semiconductor®

www.onsemi.com

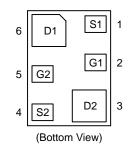
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D Max
	1.5 Ω @ 4.5 V	
23 V	2.0 Ω @ 2.5 V	200 mA
23 V	3.0 Ω @ 1.8 V	200 MA
	4.5 Ω @ 1.5 V	



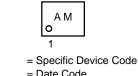


Case 713AC

PINOUT DIAGRAM



MARKING DIAGRAM



Α

= Date Code Μ

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Features

- Dual N-Channel MOSFET
- Offers a Low R_{DS(ON)} Solution in the Ultra Small 0.65 mm x 0.90 mm Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Small Signal Load Switch
- Analog Switch
- High Speed Interfacing
- Optimized for Power Management in Ultra Portable Products

Parameter			Symbol	Value	Unit
Drain-to-Source Voltag	je		V _{DSS}	23	V
Gate-to-Source Voltag	е		V _{GS}	±8	V
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	I _D	200	mA
Current (Note 1)	Sidle	$T_A = 85^{\circ}C$		140	
	$t \le 5 s$	$T_A = 25^{\circ}C$		220	
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	125	mW
	t ≤ 5 s			166	
Pulsed Drain Current	Pulsed Drain Current $t_p = 10 \ \mu s$			800	mA
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Diode) (Note 2)			۱ _S	200	mA
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

MAXIMUM RATINGS (T_J = 25° C unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.

2. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 3)	P	998	°C M
Junction-to-Ambient – t \leq 5 s (Note 3)	$R_{ hetaJA}$	751	°C/W

3. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-				-		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 2$	250 μΑ	23			V
Zero Gate Voltage Drain Current		T _J = 25°C				50	nA
	I _{DSS}	$V_{GS} = 0 V, V_{DS} = 5 V$	$T_J = 85^{\circ}C$			200	
		$V_{GS} = 0 V, V_{DS} = 16 V$	$T_J = 25^{\circ}C$			100	nA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 5.0 V$				±100	nA
ON CHARACTERISTICS (Note 4)	-				-		
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	0.4		1.0	V
Drain-to-Source On Resistance		V_{GS} = 4.5 V, I _D =	100 mA		0.8	1.5	
		V_{GS} = 2.5 V, I _D =	50 mA		1.1	2.0	0
	$R_{DS(ON)}$ $V_{GS} = 1.$		20 mA		1.4	3.0	Ω
		V _{GS} = 1.5 V, I _D =	10 mA		1.8 4.5		
Forward Transconductance	9fs	V _{DS} = 5.0 V, I _D = 125 mA 0.48			S		
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 mA 0.		0.6	1.0	V	

CAPACITANCES

Input Capacitance	C _{ISS}		12.3	
Output Capacitance	C _{OSS}	f = 1 MHz, V _{GS} = 0 V V _{DS} = 15 V	3.4	pF
Reverse Transfer Capacitance	C _{RSS}		2.5	

SWITCHING CHARACTERISTICS, V_{GS} = 4.5 V (Note 4)

Turn-On Delay Time	t _{d(ON)}		16.5		1
Rise Time	t _r	V _{GS} = 4.5 V, V _{DD} = 10 V,	25.5		
Turn-Off Delay Time	t _{d(OFF)}	I_D = 200 mA, R_G = 3 Ω	142	ns	
Fall Time	t _f		80		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

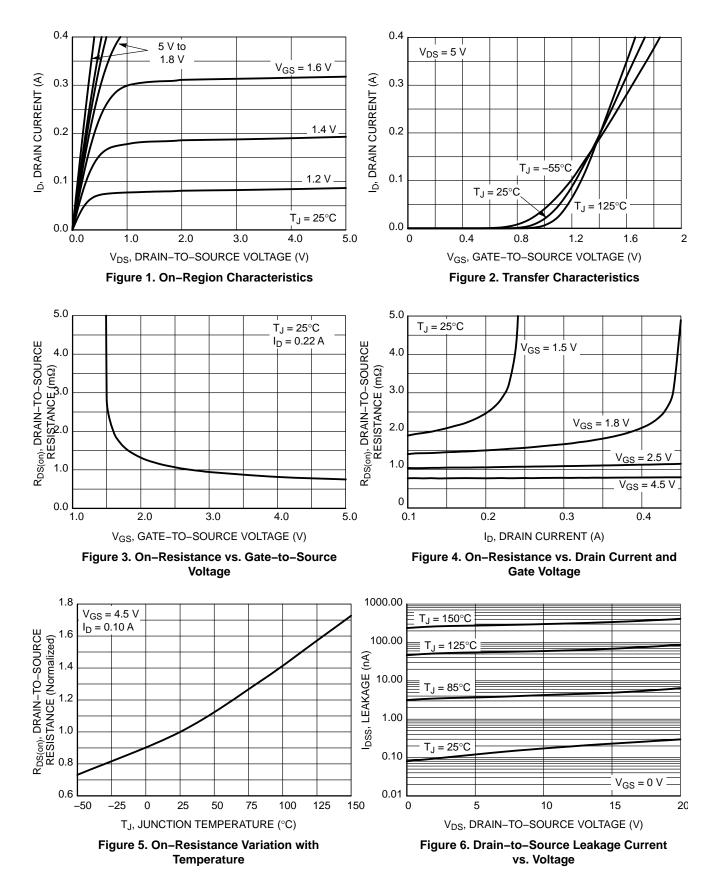
4. Switching characteristics are independent of operating junction temperatures.

ORDERING INFORMATION

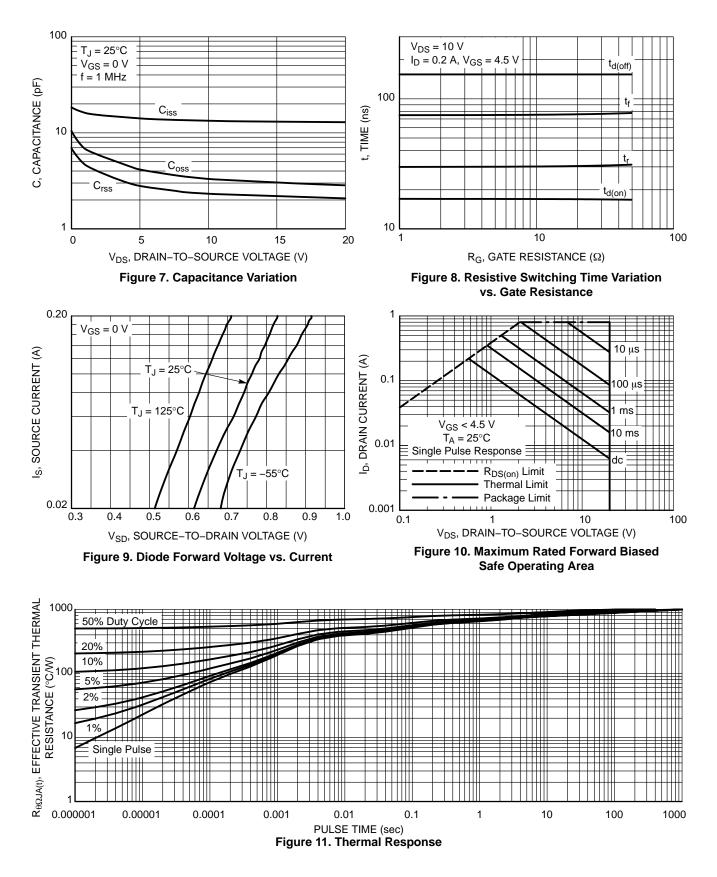
Device	Package	Shipping [†]
NTND3184NZTAG	XLLGA6 (Pb–Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

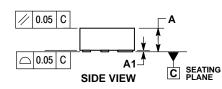


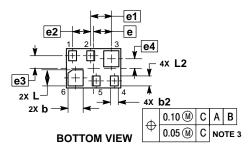
PACKAGE DIMENSIONS

XLLGA6 0.90x0.65 CASE 713AC

ISSUE O

 $\begin{array}{c} & \square & \square & \square \\ \hline \square & \square & \square & \square \\ \hline PIN ONE \\ 2x \hline 0.05 \\ 2x \hline 0.05 \\ \hline 2x \hline 0.05 \\ \hline \hline \\ D & \square \\ \hline \\ 2x \hline 0.05 \\ \hline \\ \hline \\ TOP VIEW \end{array}$

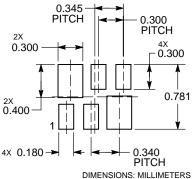




- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
 CONTROLLING DIMENSION: MILLIMETERS.
 POSITIONAL TOERANCE APPLIES TO ALL SIX I FADS

	MILLIMETERS			
DIM	MIN MAX			
Α	0.340	0.440		
A1	0.000	0.050		
b	0.200	0.300		
b2	0.080	0.180		
D	0.900 BSC			
Е	0.650 BSC			
е	0.295 BSC			
e1	0.340 BSC			
e2	0.300	0.300 BSC		
e3	0.208 BSC			
e4	0.158 BSC			
L	0.215	0.315		
L2	0.115	0.215		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights or the rights of others. ON Semiconductor and tesigned, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconducts harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Boose: 421-32-300-3010

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B